

Image

AF / 2827



Docket No.: M4065.0226/P226  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Tongbi Jiang

Application No.: 09/484,437

Art Unit: 2827

Filed: January 18, 2000

Examiner: J. Mitchell

For: DIE ATTACH CURING METHOD FOR  
BGA PRODUCT

**AMENDMENT AFTER FINAL ACTION (37 C.F.R. SECTION 1.116)**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated November 18, 2003, finally rejecting claims 1-9, 11, 12, 14-20, and 31-36, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 6 of this paper.